

Process Change Notice

Parts Affected:

Small Signal MOSFETs.

Extent of Change:

The plastic molding compound used in manufacturing has been changed to an environmentally friendly, halogen free, "green" molding compound.

Reason for Change:

To comply with customer and industry requirements to provide environmentally friendly, halogen free devices.

Effect of Change:

To identify devices manufactured using the halogen free molding compound, a "G" suffix has been added to the part #'s of the devices listed below. This change does not affect the form, fit, or function of any device. The moisture sensitivity level for all devices remains unchanged at MSL 1.

Qualification:

Standard evaluation and qualifications completed resulting in no performance differences compared to current product.

Effective Date of Change:

September 1, 2009. Existing inventory will be shipped until it is depleted.

Part Numbers Affected:

The existing part numbers listed below will be replaced by the halogen free versions containing a "G" suffix.

Existing Part #'s	Halogen Free Part #'s
CMPDM7002A	CMPDM7002AG
CMLDM7002A	CMLDM7002AG
CMLDM8002A	CMLDM8002AG
CMLDM7003	CMLDM7003G
CMLDM7003T	CMLDM7003TG
CMPDM7120	CMPDM7120G
CMLDM7120	CMLDM7120G
CMLDM8120	CMLDM8120G

Sample Availability:

Please contact Salesperson or Manufacturer's Representative.